Product Specification

PE3513

1500 MHz Low Power UltraCMOS™ Divide-by-8 Prescaler

Features

- DC to 1500 MHz operation
- Fixed divide ratio of 8
- Low-power consumption: 8 mA typical @ 3V
- RF or LV Digital Interface
- Ultra-small package: 6-lead SC-70

Product Description

The PE3513 is a high-performance static UltraCMOS™ prescaler with a fixed divide ratio of 8. Its operating frequency range is DC to 1500 MHz. The PE3513 operates on a nominal 3 V supply and draws only 8 mA. The input and output interfaces support both AC-coupled, low-Z RF as well as direct connection to low voltage positive logic devices. It is packaged in a small 6-lead SC-70 and is ideal for frequency scaling solutions

The PE3513 is manufactured on Peregrine's UltraCMOS™ process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of conventional CMOS.

Figure 1. Functional Schematic Diagram

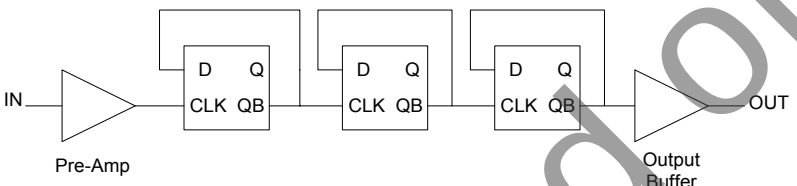


Figure 2. Package Type

6-lead SC70

Table 1. Electrical Specifications ($Z_S = Z_L = 50\ \Omega$)

V_{DD} = 3.0 V, -40° C ≤ T_A ≤ 85° C, unless otherwise specified

Parameter	Conditions	Minimum	Typical	Maximum	Units
Supply Voltage		2.85	3.0	3.15	V
Supply Current			8	12	mA
Input Frequency (F_{in})		DC		1500	MHz
Input Power (P_{in})	DC < Fin ≤ 1000 MHz (Note 1)	-10		+10	dBm
	1000 MHz < Fin ≤ 1500	-3			dBm
Output Power (P_{out})	DC < Fin ≤ 1500 MHz	2			dBm

Note 1: CMOS logic levels can be used to drive the reference input if DC coupled. Voltage input needs to be a minimum of 0.5 Vp-p. The input edge rate should be faster than 80mV/ns from DC - 10 MHz.

Table 2. DC Electrical Characteristics (-40° C ≤ T_A ≤ 85° C)

Symbol	Parameter	Condition	Typical	Unit
V_{IH}	High Level Input Voltage	2.7 V ≤ V_{DD} ≤ 3.3 V	2.0	V
V_{IL}	Low Level Input Voltage	2.7 V ≤ V_{DD} ≤ 3.3 V	0.8	V
V_{OH}	High Level Output Voltage	V_{DD} = 2.7 V; I_{OH} = 2.9 mA	2.2	V
V_{OL}	Low Level Output Voltage	V_{DD} = 2.7 V; I_{OL} = 2.6 mA	0.4	V

Table 3. AC Characteristics (-40° C ≤ T_A ≤ 85° C)

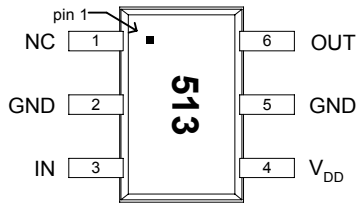
Symbol	Parameter	Condition*	Typical	Unit
t_{PHL}	Propagation Delay (High to Low)	50 MHz Pulse Train Input; C_L = 10 pF, R_L = 500 Ω	4.1	ns
t_{PLH}	Propagation Delay (Low to High)	50 MHz Pulse Train Input; C_L = 10 pF, R_L = 500 Ω	3.9	ns
t_r	Output Rise Time (10% to 90%)	50 MHz Pulse Train Input; C_L = 10 pF, R_L = 500 Ω	2.0	ns
t_f	Output Fall Time (90% to 10%)	50 MHz Pulse Train Input; C_L = 10 pF, R_L = 500 Ω	2.0	ns

** See figure 5 for AC test circuit*

Table 4. Typical Output Swing (V_{DD} = 2.7 V)

Frequency	Condition	Typical	Unit
50 MHz	200 mVp-p Sinusoidal Input; C_L = 10 pF, R_L = 500 Ω	2.3	Vp-p
500 MHz	200 mVp-p Sinusoidal Input; C_L = 10 pF, R_L = 500 Ω	2.3	Vp-p
1500 MHz	200 mVp-p Sinusoidal Input; C_L = 10 pF, R_L = 500 Ω	2.2	Vp-p

Figure 3. Pin Configuration (Top View)



SC-70

Table 5. Pin Descriptions

Pin No.	Pin Name	Description
1	N/C	No Connect. This pin should be left open.
2	GND	Ground pin. Ground pattern on the board should be as wide as possible to reduce ground impedance.
3	IN	Input signal pin. DC blocking capacitor required (100 pF typical).
4	V_{DD}	Power supply pin. Bypassing is required.
5	GND	Ground pin.
6	OUT	Divided frequency output pin. DC blocking capacitor required (100 pF typical).

Table 6. Absolute Maximum Ratings

Symbol	Parameter/Conditions	Min	Max	Units
V_{DD}	Supply voltage		4.0	V
Pin	Input Power		13	dBm
T_{ST}	Storage temperature range	-65	150	°C
T_{OP}	Operating temperature range	-40	85	°C
V_{ESD}	ESD voltage (Human Body Model)		2000	V

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

Electrostatic Discharge (ESD) Precautions

When handling this UltraCMOS™ device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified in Table 6.

Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are immune to latch-up.

Device Functional Considerations

The *PE3513* divides an input signal, up to a frequency of 1500 MHz, by a factor of eight thereby producing an output frequency at one-eighth the input frequency. To work properly with low impedance, ground referenced interfaces, the input and output signals (pins 3 & 6) must be AC coupled via an external capacitor, as shown in the test circuit in Figure 4.

The ground pattern on the board should be made as wide as possible to minimize ground impedance. See Figure 9 for a layout example.

Figure 4. Test Circuit Block Diagram

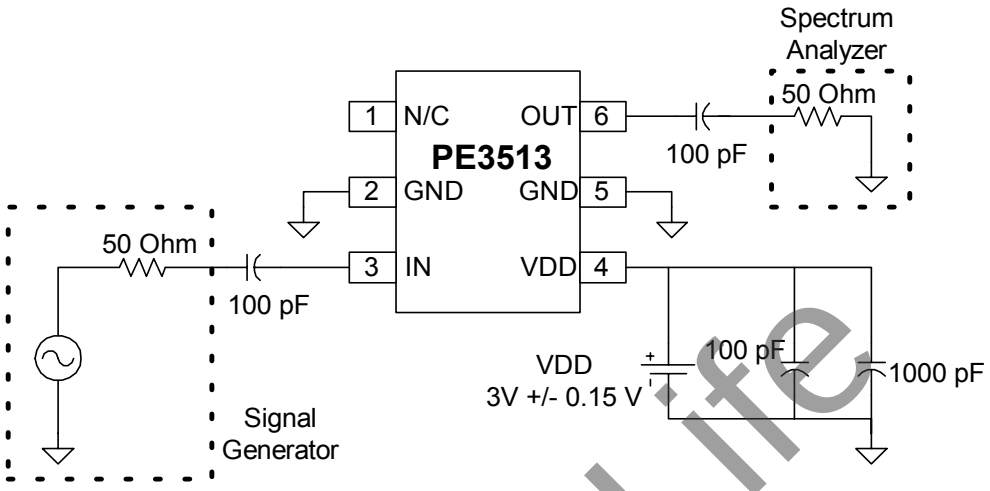
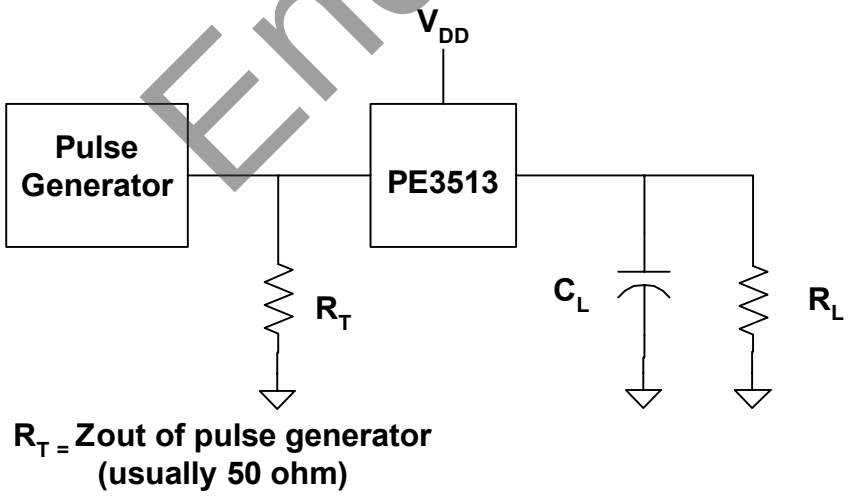


Figure 5. AC Test Circuit



R_T = Zout of pulse generator (usually 50 ohm)

Typical Performance Data: V_{DD} = 3.0 V

Figure 6. Input Sensitivity

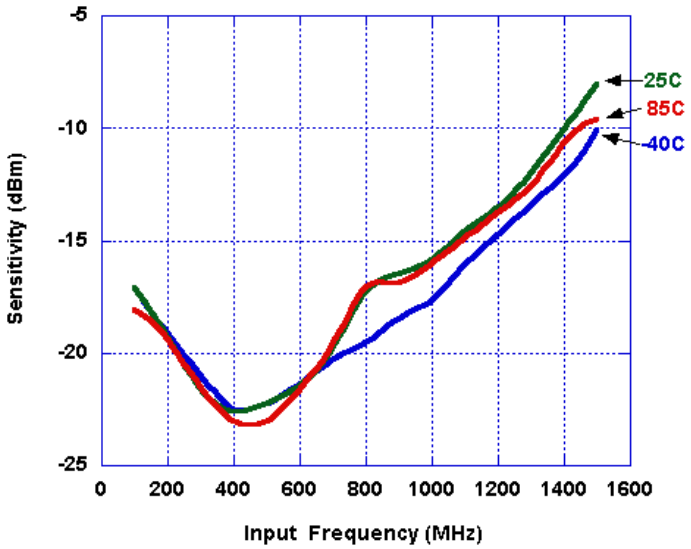


Figure 7. Device Current

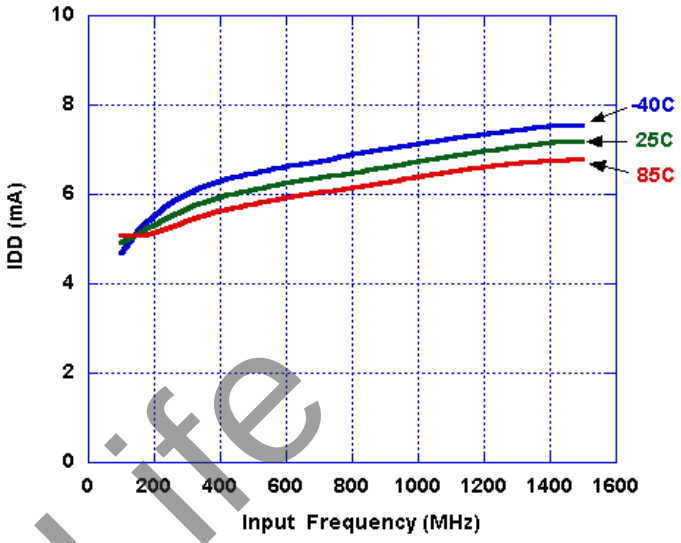
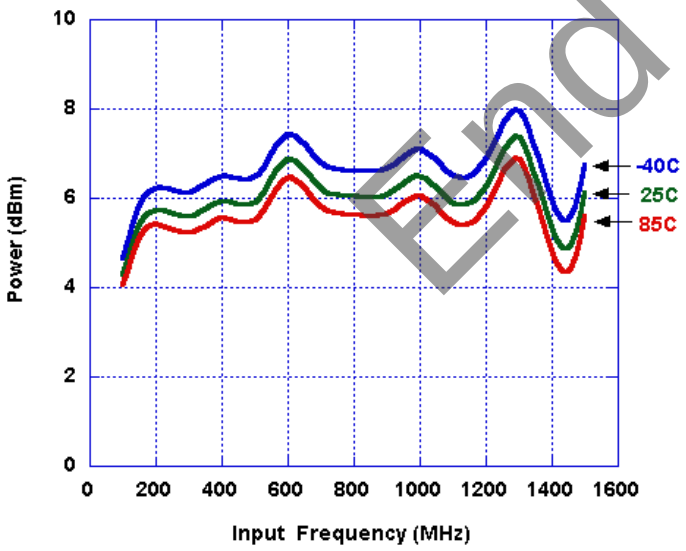


Figure 8. Output Power



Evaluation Kit

Evaluation Kit Operation

The SC-70 Prescaler Evaluation Board was designed to help customers evaluate the *PE3513* divide-by-8 prescaler. On this board, the device input (pin 3) is connected to connector J1 through a 50 Ω transmission line. A series capacitor (C1) provides the necessary DC block for the device input. A value of 100 pF was used for this board layout; other applications may require a different value.

The device output (pin 6) is connected to J3 through a 50 Ω transmission line. A series capacitor (C5) provides the necessary DC block for the device output. This capacitor value must be chosen to have a low impedance at the desired output frequency of the device. A value of 100 pF was chosen for the evaluation board. At both input and output, select a capacitor value that offers low series reactance while ensuring that any parasitic resonances are well above the operating bandwidth.

The board is constructed of a two-layer FR4 material with a total thickness of 0.031". The bottom layer provides ground for the RF transmission lines. The transmission lines were designed using a coplanar waveguide above ground plane model with trace width of 0.030", trace gaps of 0.007", dielectric thickness of 0.028", metal thickness of 0.0014", and ε_r of 4.4. Note that the predominate mode of these transmission lines is coplanar waveguide. Liberal numbers of plated through holes unite the top and bottom ground areas for best performance.

J6 provides DC power to the device via pin 4. Two decoupling capacitors (100 pF, 1000 pF) are included on this trace. It is the customer's responsibility to determine proper supply decoupling for their design application.

Applications Support

If you have a problem with your evaluation kit or if you have applications questions call (858) 731-9400 and ask for applications support. You may also contact us by fax or e-mail:
Fax: (858) 731-9499
E-Mail: help@psemi.com

Figure 9. Evaluation Board Layouts
Peregrine Specification 101/0110

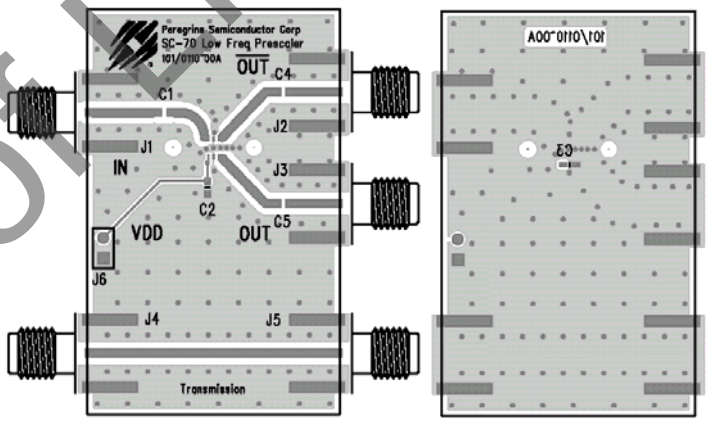


Figure 10. Evaluation Board Schematic
Peregrine Specification 102/0191

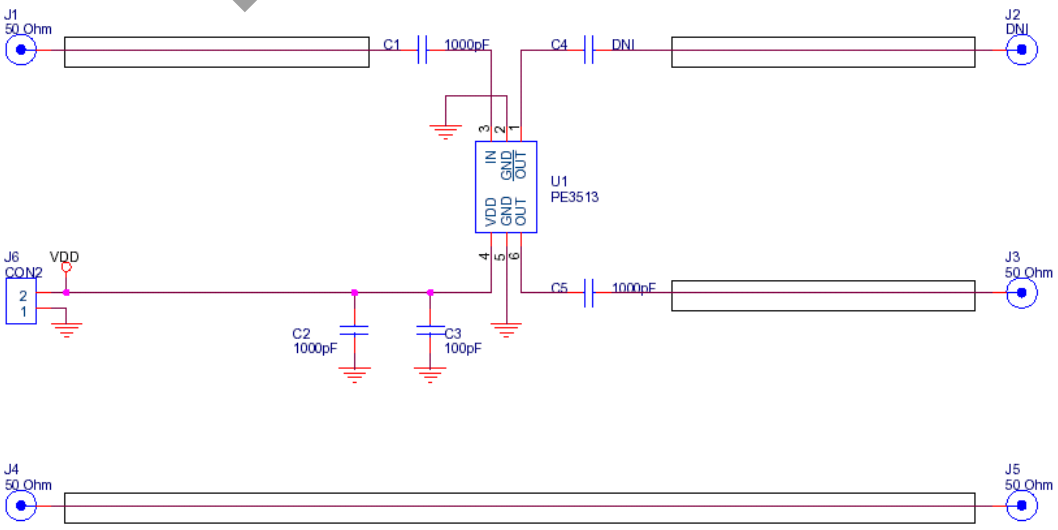
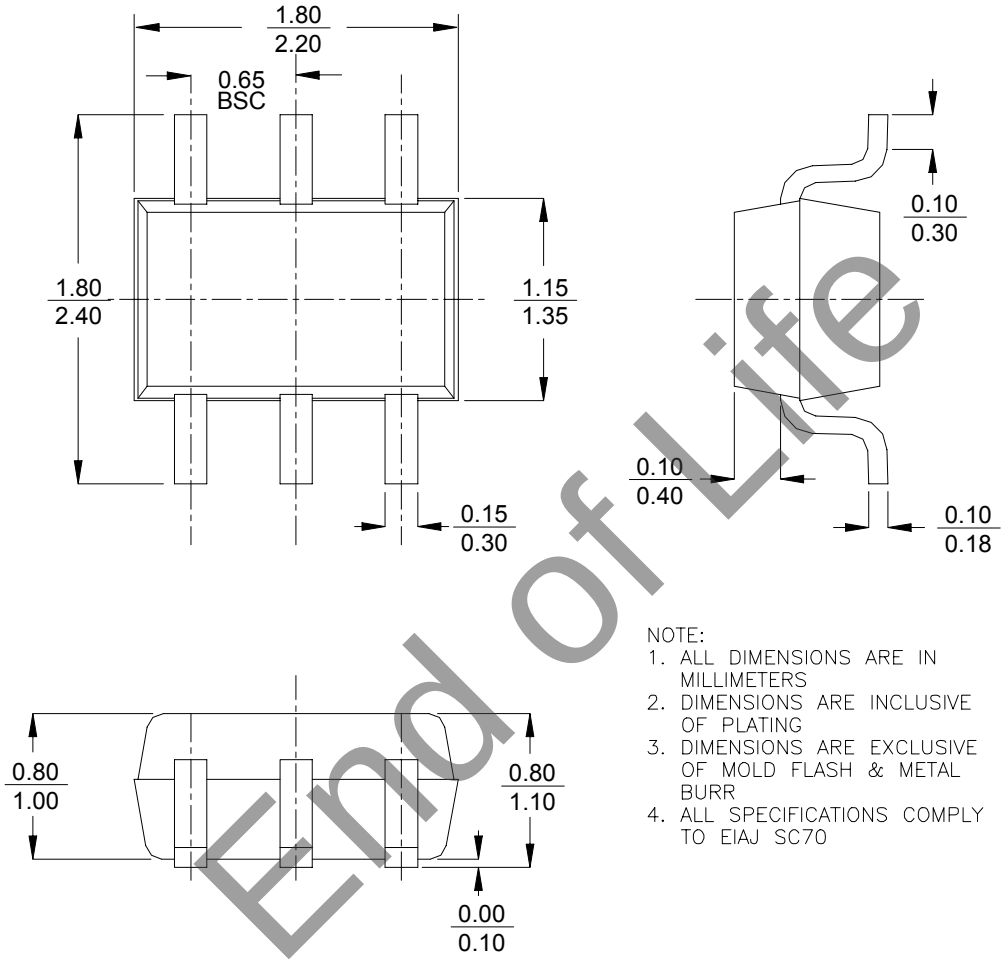


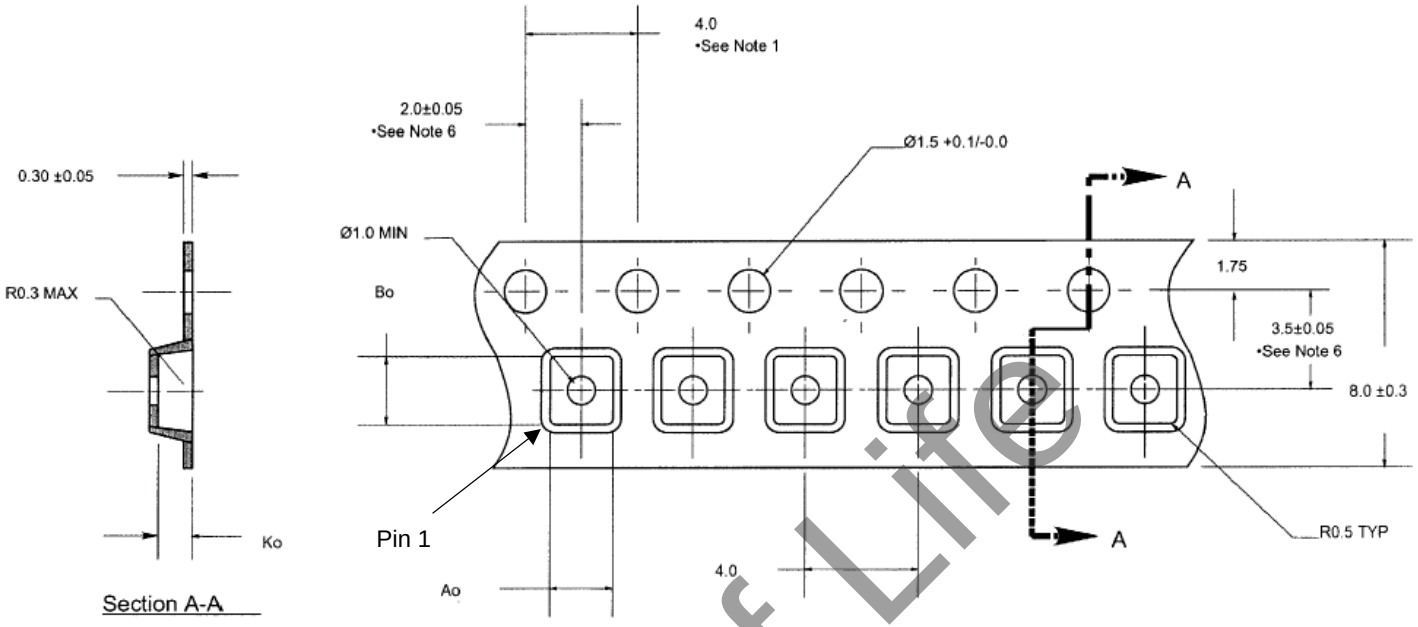
Figure 11. Package Drawing

6-lead SC-70



NOTE:
1. ALL DIMENSIONS ARE IN MILLIMETERS
2. DIMENSIONS ARE INCLUSIVE OF PLATING
3. DIMENSIONS ARE EXCLUSIVE OF MOLD FLASH & METAL BURR
4. ALL SPECIFICATIONS COMPLY TO EIAJ SC70

Figure 12. Tape and Reel Specifications



Ao = 2.25 mm
Bo = 2.4 mm
Ko = 1.2 mm

Notes:
1. 10 sprocket hole pitch cumulative tolerance ±.02.
2. Camber not to exceed 1mm in 100mm.
3. Material: Black Conductive Advantek Polystyrene.
4. Ao and Bo measured on a plane 0.3mm above the bottom of the pocket
5. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

Table 7. Ordering Information

Order Code	Part Marking	Description	Package	Shipping Method
3513-51	513	PE3513G-06SC70-7680A	Green 6-lead SC-70	Tape or loose
3513-52	513	PE3513G-06SC70-3000C	Green 6-lead SC-70	3000 units / T&R
3513-00	PE3513-EK	PE3513-06SC70-EK	Evaluation Kit	1 / Box

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Data Sheet Identification

Advance Information

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Preliminary Specification

The data sheet contains preliminary data. Additional data may be added at a later date. Peregrine reserves the right to change specifications at any time without notice in order to supply the best possible product.

Product Specification

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